SVPB Series

RoHS compliance

Low profile

This is a low profile series based on the SVPA series. Suitable for miniaturizing devices and circuits. This product can support lead free-reflow.*2





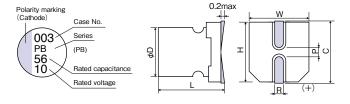


■ Specifications

Items	Condition			Specifications					
Rated voltage (V)	-		2.5	4.0	6.3	10	16	20	
Surge voltage (V)	Room temper	ature		3.3	5.2	8.2	12	18	23
Category temperature range (°C)	_			-55 to +105					
Capacitance tolerance (%)	120Hz/20℃			M:±20					
Dissipation Factor (DF)	120Hz/20℃		Please see the attached characteristics list						
Leakage current*1	Rated voltage applied, after 2 minutes		Please see the attached characteristics list						
Equivalent series resistance (ESR)	100kHz to 300kHz/20°C			Please see the attached characteristics list					
Characteristics of impedance ratio at high temp.	Based the value at	-55℃	Z/Z200	0.75 to 1.25					
and low temp.	100kHz, +20℃	+105℃	Z/Z20c	0.75 to 1.25					
Endurance	105℃, 1,000h, Rated voltage applied	△C/C		Within ±20% of the initial value(±30% for C5 size)					
		DF		Within 1.5 times of the initial limit					
Endardice		ESR		Within 1.5 times of the initial limit					
		LC		Within the initial limit					
		ΔΙ	C/C	Within ±20% of the initial value					
Damp heat(Steady state)	60°C, 90 to 95%RH, 1.000h.	DF		Within 1.5 times of the initial limit					
Damp heat(Steady State)	No-applied voltage	ESR		Within 1.5 times of the initial limit					
		LC		Within the initial limit (after voltage processing)					
Resistance to soldering heat*2		△C/C		Within $\pm 10\%$ of the initial value ($\pm 20\%$ for C5 size)					
	VPS (230℃ X 75s)	DF		Within 1.3 times of the initial limit					
	V. 5 (2000 / 703)	ESR		Within 1.3 times of the initial limit					
		L	_C	Within the initial limit (after voltage processing)				ng)	

^{*1} In case of some problems for measured values, measure after applying rated voltage for 120 minutes at 125°C.

Marking and dimensions



Size code	φ D ±0.5	L +0.1 L -0.4	W ±0.2	H ±0.2	C ±0.2	R	P ±0.2
C5	6.3	4.9	6.6	6.6	7.3	0.6 to 0.8	2.1
C55	6.3	5.4	6.6	6.6	7.3	0.6 to 0.8	2.1

(unit: mm)

■ Size list

					rated voitage
2.5	4.0	6.3	10	16	20
					C5
					C55
				C5	
			C5		
		C5			
	C5				
C5					
		C5	C5	C5 C5	2.5 4.0 6.3 10 16 C5 C5 C5 C5

PB

S

OS-CON OS-CON Line-un

Guidelines and precautions for use

Image of case size
Products list
Packing specifications (SMD type)
Packing specifications (SAD type)
Packing specifications (Radial lead type)

Fundamental structure

Characteristics

Reliability

SVPE SVPS

SVPF

SVPD SVPB

SVPA SVQP

SEPF SEPC

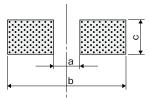
SEQP SEP

^{*2} Please refer to page 14 for reflow soldering conditions.

■ SVPB series characteristics list

Size code	Part number	Rated voltage (V)	Rated capacitance (µF)	ESR (mΩ) (max) 100kHz to 300kHz/20°C	Rated ripple current 100kHz (mArms) at 105°C	DF (% max)	Leakage current (µA)(max) After 2 minutes
	20SVPB15M	20	15	45	2000	12	120
	16SVPB33M	16	33	40	1670	12	211
C5	10SVPB56M	10	56	40	1670	12	224
U5	6SVPB82M	6.3	82	40	1670	12	207
	4SVPB100M	4.0	100	40	1670	12	160
	2R5SVPB120M	2.5	120	40	1670	12	120
C55	20SVPB22M	20	22	35	2000	12	88

■ Recommended land pattern dimension of PWB



			(unit : mm)
Size code	а	b	С
C5	2.1	9.1	1.6
C55	2.1	9.1	1.6
-			

■ Frequency coefficient for ripple current

Frequency	120Hz ≤ f < 1kHz	1kHz ≤ f < 10kHz	$10kHz \le f < 100kHz$	100kHz ≤ f ≤ 500kHz
Coefficient	0.05	0.3	0.7	1

Guidelines and precautions for use

Image of case size

Products list
Packing specifications (SMD type)
Packing specifications (SMD type)
Packing specifications Packing specifications (SMD type) Packing specifications (Radial lead type)

Fundament structure

Characterist

Reliability Fundamental structure Characteristics

> SVPF SVPE **SVPS** SVPD

SEPF SEPC

SEQP SEP